



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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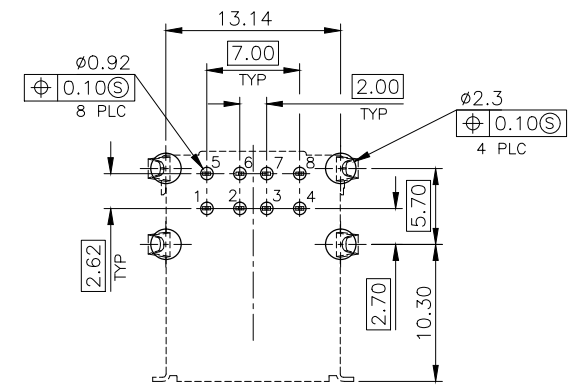
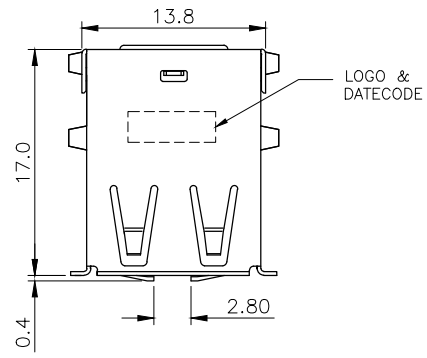
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

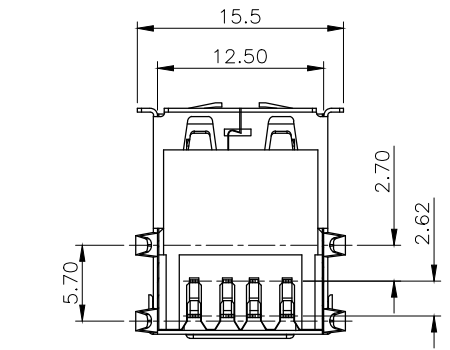
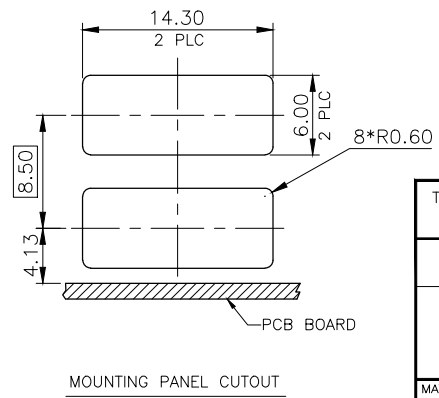
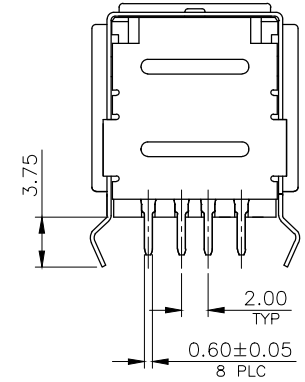
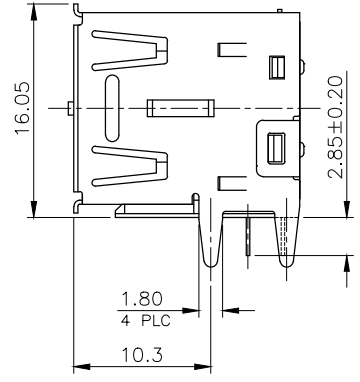
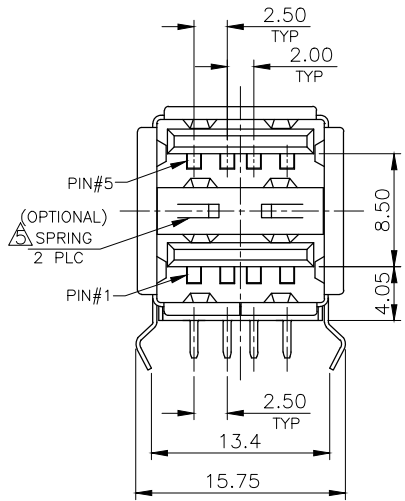


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LOC	DIST	REVISIONS					
DW		P	LTR	DESCRIPTION	DATE	DWN	APVD
		C		REVISED (ECR-14-010868)	22JUL2014	S.C.	H.L.



RECOMMENDED P.C.B LAYOUT
 TOP VIEW (TOLERANCE: ±0.05)



NOTES:

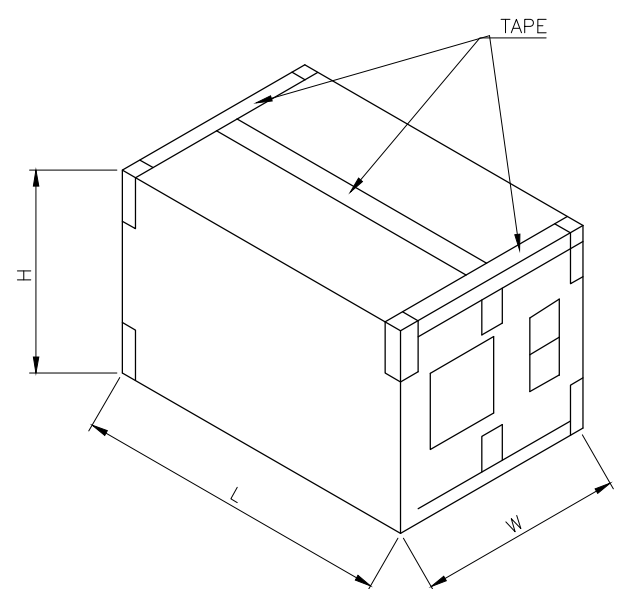
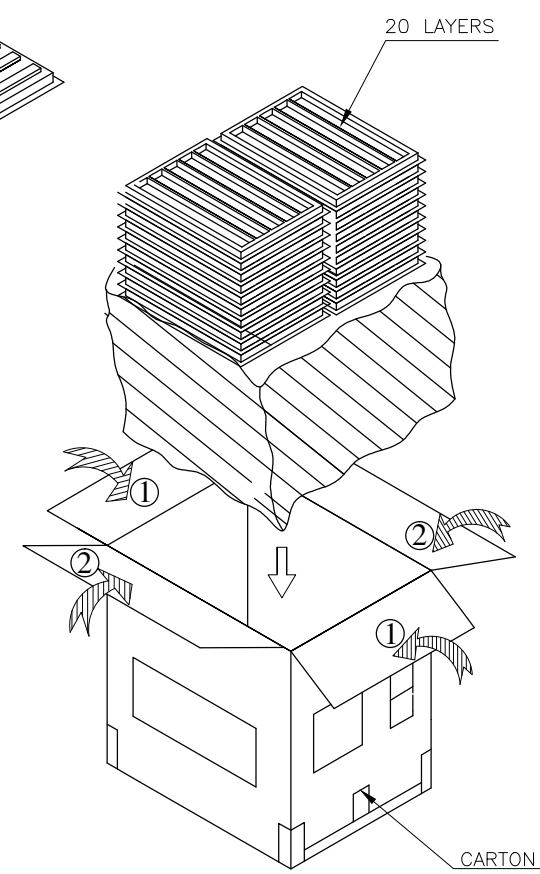
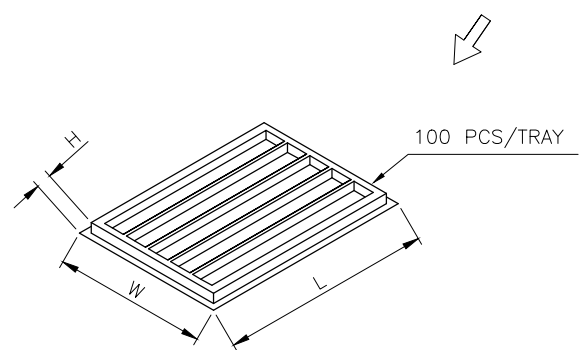
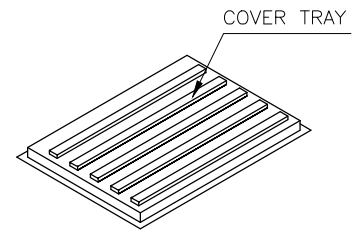
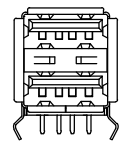
- MATERIAL:
 - HOUSING: SEE TABLE (PA66 WITH 30% G.F, UL94 V-0, BLACK COLOR. OR LCP WITH 30% G.F, UL94 V-0, BLACK COLOR.)
 - CONTACT: BRASS, T=0.25.
 - SHELL: SPCC.
 - REAR SHELL: SPCC.
 - SPRING: SPCC.
- FINISH:
 - CONTACT: GOLD PLATING (SEE TABLE) ON CONTACT AREA, 2.54um [100u"] MIN. BRIGHT-TIN PLATING ON SOLDER TAIL AREA, 1.27um [50u"] MIN. NICKEL UNDERPLATING OVERALL.
 - SHELL: 2.54um [100u"] MIN. BRIGHT-TIN PLATING, 1.27um [50u"] MIN. NICKEL UNDERPLATING OVERALL.
 - REAR SHELL: 1.27um [50u"] MIN. NICKEL PLATING.
 - SPRING : 1.27um [50u"] MIN. NICKEL PLATING.
- RECOMMENDED P.C.B THICKNESS :1.6mm.
- WAVE SOLDER CAPABLE TO 265°C PER TE SPEC. 109-202, CONDITION B.
- THE SPRING IS OPTIONAL.

0.381um [15u"]	W/ O	PA66	1-1775468-2
	W/	PA66	1-1775468-1
GOLD FLASH	W/ O	LCP	1775468-2
	W/	PA66	1775468-1
MIN. GOLD THICKNESS	△ SPRING	HSG MATERIAL	PART NUMBER

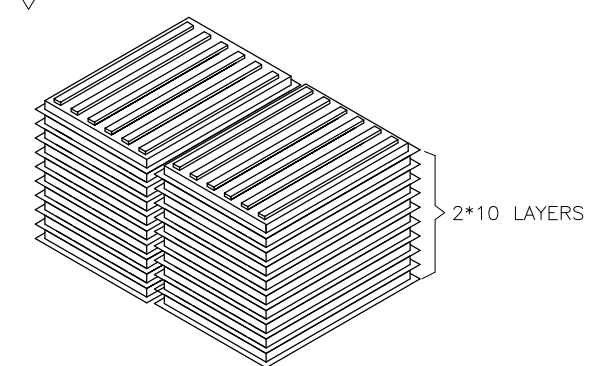
THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	30MAR2007	TE Connectivity	
DIMENSIONS: mm		J. LEE			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		CHK	30MAR2007		
0 PLC ± - 1 PLC ± 0.3 2 PLC ± 0.2 3 PLC ± 0.15 4 PLC ± - ANGLES ± 3°		APVD	30MAR2007		
MATERIAL SEE NOTE		NAME		USB A TYPE, RECEPTACLE DUAL PORT, R/A, DIP CONNECTOR	
FINISH SEE NOTE		PRODUCT SPEC		SIZE	CAGE CODE
		APPLICATION SPEC		DRAWING NO	RESTRICTED TO
		108-57519		WEIGHT	SCALE
		CUSTOMER DRAWING		5.31 GRAMS	SHEET
				A300779	1 of 2
				C=1775468	REV C

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LOC DW	DIST	REVISIONS			
P	LTR	DESCRIPTION	DATE	DWN	APVD
		SEE SHEET 1.			



- NOTES:
1. DIMENSION:
 TRAY: L= 270, W=235, H=25
 SHIPPING CARTON: L= 485, W=280, H=210
 2. QUANTITY: (SEE TABLE)
 3. CARTON WEIGHT: (SEE TABLE)
 4. PE BAGS SEALED AND ADD DESICCANT.



11.6	10.6	100	20	2000
GROSS WEIGHT	NET WEIGHT	PCS/TRAY	TRAYS/CARTON	PCS/CARTON

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN	TE Connectivity		
DIMENSIONS: mm		CHK	NAME		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD	USB A TYPE, RECEPTACLE DUAL PORT, R/A, DIP CONNECTOR		
0 PLC ± -		PRODUCT SPEC	SIZE	CAGE CODE	DRAWING NO
1 PLC ± -		APPLICATION SPEC	A3	00779	C=1775468
2 PLC ± -		WEIGHT	RESTRICTED TO		
3 PLC ± -		CUSTOMER DRAWING	SCALE	SHEET	REV
4 PLC ± -				2 of 2	C
ANGLES ± -					
MATERIAL					
FINISH					